

PATENT ASSIGNMENT

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SUBMISSION TYPE:		NEW ASSIGNMENT
NATURE OF CONVEYANCE:		ASSIGNMENT
CONVEYING PARTY DATA		
Name		Execution Date
Chao-Cheng Lee		11/10/2007
Chieh-Min Feng		11/10/2007
RECEIVING PARTY DATA		
Name:	Realtek Semiconductor Corp.	
Street Address:	No. 2, Innovation Rd. II	
Internal Address:	Science-Based Industrial Park	
City:	Hsinchu	
State/Country:	TAIWAN	
Postal Code:	300	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	11808869	
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Total Attachments: 1 source=assignment#page1.tif		

CH 11808869 \$40.00

ASSIGNMENT OF PATENT APPLICATION

For good and valuable consideration, receipt of which hereby acknowledged,

I/We,

- (a) CHAO-CHENG LEE
- (b) CHIEH-MIN FENG

residing at

- (a) HF, NO. 29, HU PIN 2ND RD., SCIENCE-BASED INDUSTRIAL PARK, TAIWAN 300 R.O.C.
- (b) NO. 1, LANE 157, CHENG KUNG 8 RD., CHU PEI CITY, HSIN CHU COUNTY, TAIWAN, R.O.C

assign and transfer to: **Realtek Semiconductor Corp.**

a corporation organized under the law of Taiwan and having a place of business at: **No. 2, Innovation Rd. II, Science-Based Industrial Park, Hsinchu 300, Taiwan, R.O.C.**

its successors and assigns, my entire right, title and interest, including the right of priority, in, to and under an application for Letters Patent of the United States entitled: **AMPLIFIER WITH COMMON-MODE FEEDBACK CIRCUIT**

including divisions, reissues, continuations and extensions thereof, and all rights of priority without further authorization from me, I agree to execute all papers useful in connection with said United States application, and generally to do everything possible to aid said assignee, its successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in United States; and I request the Commissioner of Patents and Trademarks to issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Joint Inventor (a)	CHAO-CHENG LEE		
Inventor's Signature	<i>Chao Cheng Lee</i>	Date	NOV 10 2007
Residence	TAIWAN	Citizenship	R.O.C.

Joint Inventor (b)	CHIEH-MIN FENG		
Inventor's Signature	<i>Chieh-Min Feng</i>	Date	NOV 10 2007
Residence	TAIWAN	Citizenship	R.O.C.

Joint Inventor (c)			
Inventor's Signature		Date	
Residence		Citizenship	

Joint Inventor (d)			
Inventor's Signature		Date	
Residence		Citizenship	

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